



30V COMPLEMENTARY ENHANCEMENT MODE MOSFET H-BRIDGE

Product Summary

Device	V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
	001/	$25m\Omega$ @ V_{GS} = $10V$	6.0
N-Channel 30V		$40 \text{m}\Omega$ @ $V_{GS} = 4.5 \text{V}$	4.6
D 01	00) ($50m\Omega$ @ V_{GS} = -10 V	-4.2
P-Channel	-30V	$80 \text{m}\Omega$ @ $V_{GS} = -4.5V$	-3.2

Description and Applications

This new generation complementary MOSFET H-Bridge features 2 N and 2 P channel in an SOIC package. Qualified to AECQ101 the H bridge is ideally suited to driving:

- Solenoids
- DC Motors
- Audio Outputs

Features

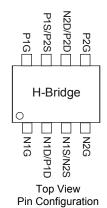
- 2 x N + 2 x P channels in a SOIC package
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

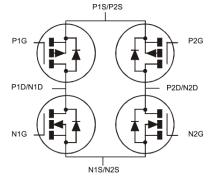
Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe.
 Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.074 grams (approximate)



Top View





Internal Schematic

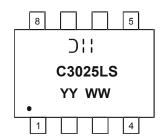
Ordering Information (Note 5)

Ĭ	Dart Number	Compliance	Caso	Dockoning
	Part Number	Compliance	Case	Packagilig
	DMHC3025LSDQ-13	Automotive	SO-8	2,500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_grade_definitions/.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



Oll = Manufacturer's Marking
C3025LS = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 09 = 2009)
WW = Week (01 - 53)



Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Total Power Dissipation (Note 6)		P _D	1.5	W	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Б	83	°C/W	
Thermal Resistance, Junction to Ambient (Note 6)	t < 10s	$R_{\theta JA}$	50		
Thermal Resistance, Junction to Case		$R_{ heta JC}$	14.5		
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to 150	°C	

Maximum Ratings N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±20	V
	Steady State	T _A = +25°C T _A = +70°C	I _D	6.0 4.8	А
Continuous Drain Current (Note 6) V _{GS} = 10V	t < 10s	T _A = +25°C T _A = +70°C	I _D	7.8 6.1	А
Continuous Drain Current (Note SVV - 4.5V	Steady State	T _A = +25°C T _A = +70°C	I _D	4.6 3.6	Α
Continuous Drain Current (Note 6) V _{GS} = 4.5V t < 10s		T _A = +25°C T _A = +70°C	I _D	6.1 4.8	А
Maximum Continuous Body Diode Forward Current (Note 5)			I _S	2.5	Α
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	60	А

Maximum Ratings P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage	V _{DSS}	30	V		
Gate-Source Voltage	_		V _{GSS}	±20	V
		T _A = +25°C T _A = +70°C	I _D	-4.2 -3.3	А
Continuous Drain Current (Note 6) V _{GS} = -10V	t < 10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-5.4 -4.3	А
Continuous Dunis Coment (Note C) V - 45V	Steady State	T _A = +25°C T _A = +70°C	I _D	-3.2 -2.5	А
Continuous Drain Current (Note 6) V _{GS} = -4.5V		$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	-4.3 -3.3	А
Maximum Continuous Body Diode Forward Current (Note 6)			Is	-2.5	Α
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	-30	A

Note: 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.



Electrical Characteristics N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	30		_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	0.5	μA	$V_{DS} = 30V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±1	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	1		2	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$
Static Drain-Source On-Resistance		_	19	25	mΩ	$V_{GS} = 10V, I_D = 5A$
Static Dialii-Source Off-Resistance	R _{DS (ON)}	_	26	40	11122	$V_{GS} = 4.5V, I_D = 4A$
Forward Transfer Admittance	Y _{fs}	_	4	_	S	$V_{DS} = 5V, I_{D} = 5A$
Diode Forward Voltage	V _{SD}	_	0.70	1.2	V	V _{GS} = 0V, I _S = 1.7A
DYNAMIC CHARACTERISTICS (Note 8)				•		
Input Capacitance	Ciss	_	590	_		V _{DS} = 15V, V _{GS} = 0V, f = 1MHz
Output Capacitance	Coss	_	122	_	pF	
Reverse Transfer Capacitance	Crss	_	58	_		
Gate resistance	R_g	_	1.5	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qq	_	5.4	_		
Total Gate Charge (V _{GS} = 10V)	Qq	_	11.7	_	nC	V 45V L 7.0A
Gate-Source Charge	Q _{gs}	_	1.8	_	IIC	$V_{DS} = 15V, I_D = 7.8A$
Gate-Drain Charge	Q _{gd}	_	2.1	_		
Turn-On Delay Time	t _{D(on)}	_	11.2	_		
Turn-On Rise Time	t _r		15	_		$V_{DD} = 15V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t _{D(off)}	-	17.5	_	ns	$R_L = 2.4\Omega$, $R_G = 1\Omega$,
Turn-Off Fall Time	t _f	_	8.7	_		
Reverse Recovery Time	t _{rr}	-	18.3	_	ns	1 404 11/14 5004/
Reverse Recovery Charge	Q _{rr}	_	12	_	nC	I _F = 12A, di/dt = 500A/μs

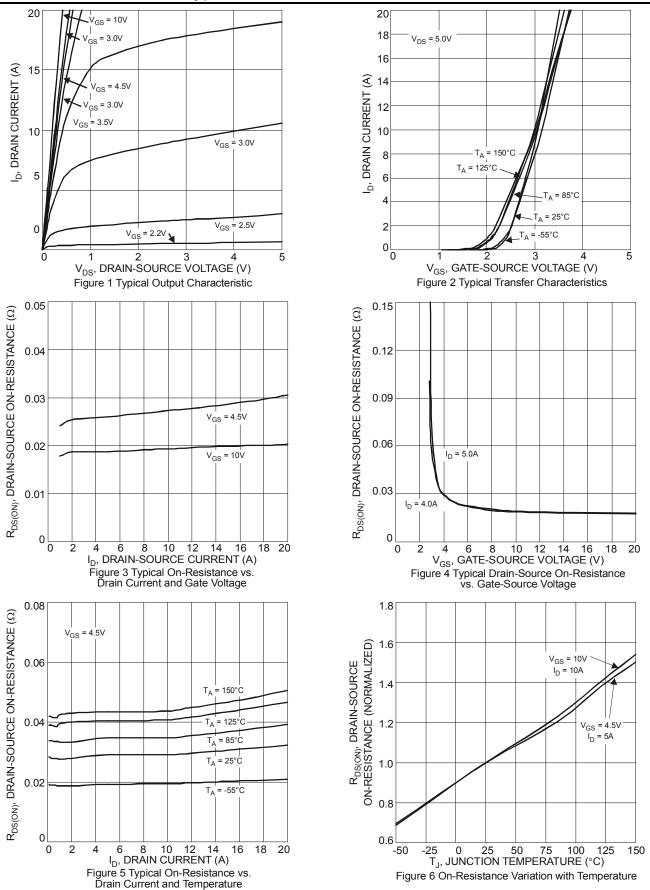
Electrical Characteristics P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	-30	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}	_	_	-0.5	μA	$V_{DS} = -30V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±1	μΑ	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	-1	-	-2	٧	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
Static Drain-Source On-Resistance			43	50	mΩ	$V_{GS} = -10V, I_D = -5A$
Static Drain-Source On-Resistance	R _{DS} (ON)	_	68	80	11122	$V_{GS} = -4.5V$, $I_{D} = -4A$
Forward Transfer Admittance	Y _{fs}	-	3.5	_	S	$V_{DS} = -5V, I_{D} = -5A$
Diode Forward Voltage	V_{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -1.7A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	_	631	_	pF	., .=.,
Output Capacitance	Coss	_	137	_	pF	V _{DS} = -15V, V _{GS} = 0V, -f = 1MHz
Reverse Transfer Capacitance	C _{rss}	_	70	_	pF	- I - IIVIHZ
Gate resistance	R_g	_	10.8	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (V _{GS} = 4.5V)	Qg	_	5.5	_	nC	
Total Gate Charge (V _{GS} = 10V)	Qg	_	11.4	_	nC	\/ - 45\/ - CA
Gate-Source Charge	Q _{gs}	_	1.8	_	nC	$V_{DS} = -15V, I_D = -6A$
Gate-Drain Charge	Q_{gd}	_	2.4	_	nC	
Turn-On Delay Time	t _{D(on)}	_	7.5	_	ns	
Turn-On Rise Time	t _r	_	4.9	_	ns	$V_{DD} = -15V, V_{GS} = -10V,$
Turn-Off Delay Time	t _{D(off)}	_	28.2	_	ns	$R_G = 6\Omega$, $I_D = -1A$
Turn-Off Fall Time	t _f		13.5	_	ns	1
Reverse Recovery Time	t _{rr}		15.1	_	ns	1 404 45/45 5004/55
Reverse Recovery Charge	Q _{rr}	_	15.3	_	nC	I _F = 12A, di/dt = 500A/μs

7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing. Notes:



Typical Characteristics - N-CHANNEL







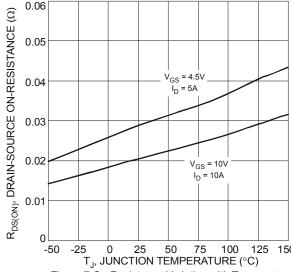
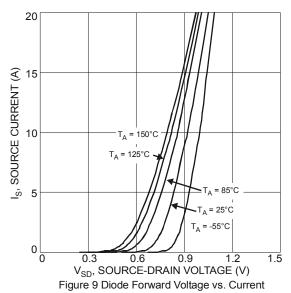
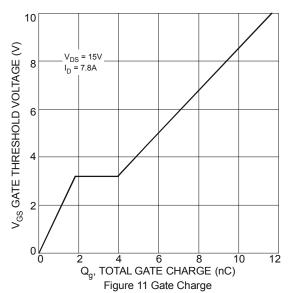


Figure 7 On-Resistance Variation with Temperature





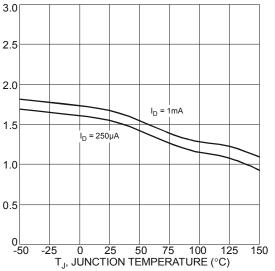
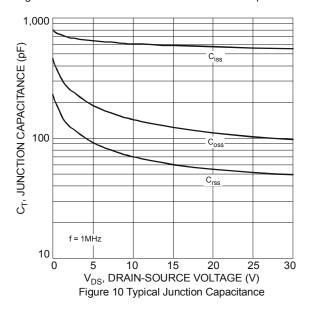


Figure 8 Gate Threshold Variation vs. Ambient Temperature





Typical Characteristics - P-CHANNEL

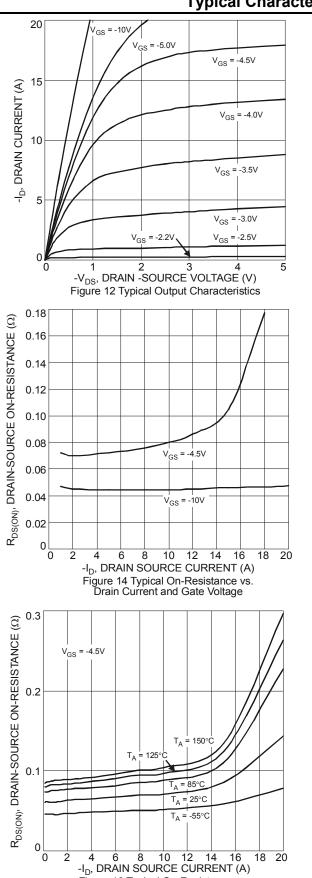
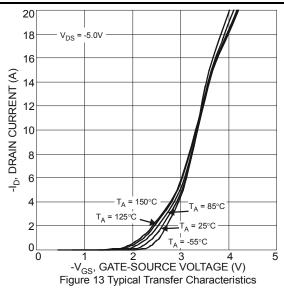
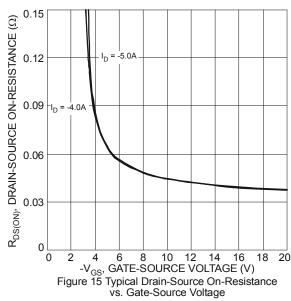
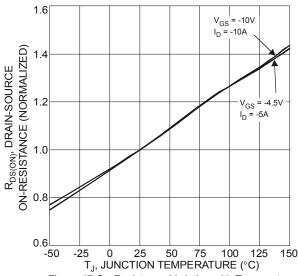


Figure 16 Typical On-Resistance vs.

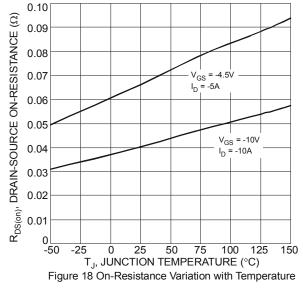
Drain Current and Temperature

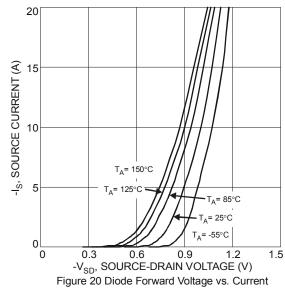


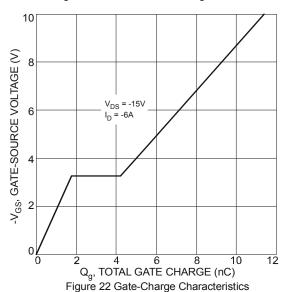












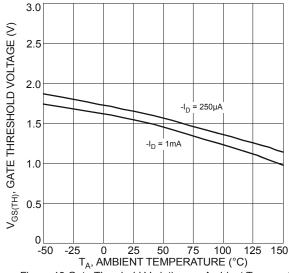
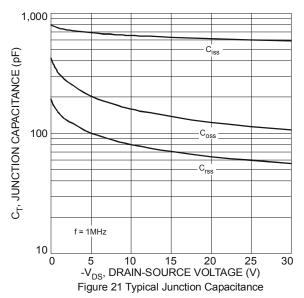


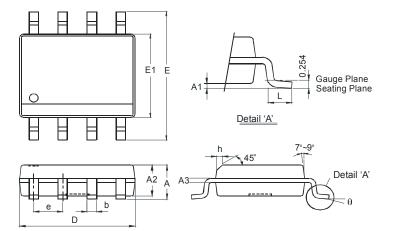
Figure 19 Gate Threshold Variation vs. Ambient Temperature





Package Outline Dimensions

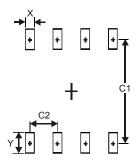
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SO-8						
Dim	Min	Max				
Α	-	1.75				
A1	0.10	0.20				
A2	1.30	1.50				
A3	0.15	0.25				
b	0.3	0.5				
D	4.85	4.95				
Е	5.90	6.10				
E1	3.85	3.95				
е	1.27	Тур				
h	-	0.35				
L	0.62	0.82				
θ	0°	8°				
All Di	All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.60
Υ	1.55
C1	5.4
C2	1.27



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